5645169-3 - ACTIVE

TE Internal #: 5645169-3 Card Edge Power Connectors, Board-to-Board, 98 Position, .1 in [2.54 mm] Centerline, Printed Circuit Board, Power & Signal, 98 Power Positions

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Connector System: Board-to-Board

Number of Positions: 98

Centerline (Pitch): 2.54 mm [.1 in]

Connector & Contact Terminates To: Printed Circuit Board

Contact Current Rating (Max): 3A

Features

Product Type Features

Housing Type	Receptacle
Product Type	Connector Assembly
Connector System	Board-to-Board
Contact Type	Socket
Connector & Contact Terminates To	Printed Circuit Board
Type of Connector	Special 18/31 Dual Combination
Configuration Features	
Keying & Polarized Position Locations	0
Keying & Polarized Position Locations PCB Mount Orientation	0 Vertical
PCB Mount Orientation	Vertical
PCB Mount Orientation Number of Positions	Vertical 98
PCB Mount Orientation Number of Positions Number of Power Positions	Vertical 98 98
PCB Mount Orientation Number of Positions Number of Power Positions Number of Signal Positions	Vertical 98 98 0

Electrical Characteristics

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Operating Voltage	400 V
Contact Features	
Contact Termination Area Plating Finish	Matte
Contact Mating Area Plating Material Thickness	.76 µm[30 µin]
Contact Underplating Material	Nickel
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	3 A
Contact Mating Area Plating Material	Gold
Contact Termination Area Plating Material	Tin
Contact Termination Area Plating Thickness	2.54 µm
Termination Features	
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Solder Tail
Connector Mounting Type	Board Mount
Mating Alignment	With
Mating Retention	Without
Mating Alignment Type	Keyed
Housing Features	
End Caps	Without
Centerline (Pitch)	2.54 mm[.1 in]
Housing Color	Black
Housing Material	Polyester GF
Dimensions	
Card Slot Depth	7.49 mm[.295 in]
Power Contact Centerline	2.54 mm[.1 in]
Height	15.49 mm[.61 in]
Jsage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]

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Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Other	
Position Locations Omitted	0
For Use With	Printed Circuit Board
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant Compliant
	Compliant
EU ELV Directive 2000/53/EC	Compliant No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 202
EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016	Compliant No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 202 (224)
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Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

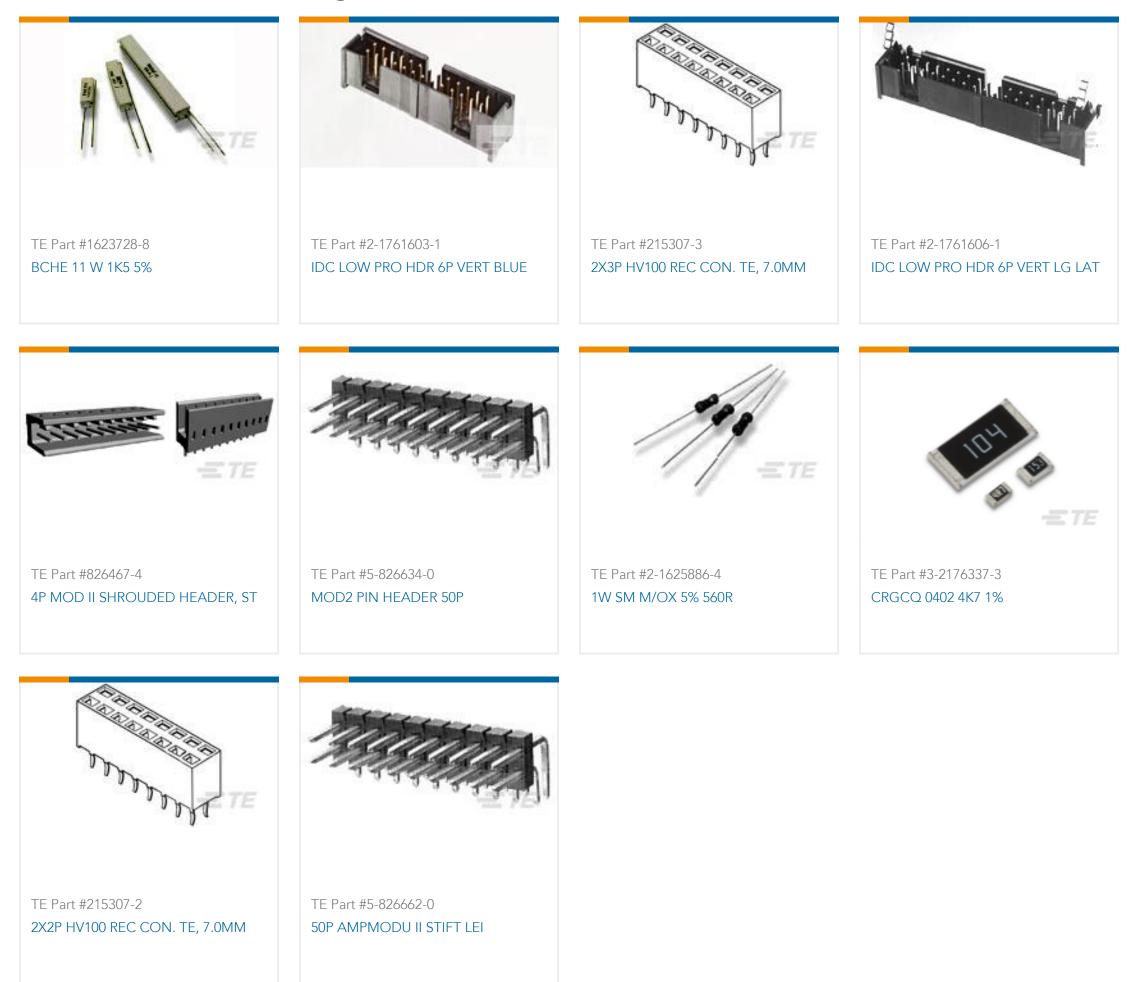
Compatible Parts

Card Edge Power Connectors, Board-to-Board, 98 Position, .1 in [2.54 mm] Centerline, Printed Circuit Board, Power & Signal, 98 Power Positions





Customers Also Bought



Documents

Product Drawings CONN SEC II 49 POS 100C/L

English

CAD Files

Customer View Model

ENG_CVM_CVM_5645169-3_B.2d_dxf.zip

English

3D PDF

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3D

Customer View Model ENG_CVM_CVM_5645169-3_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5645169-3_B.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance MD_5645169-3_04042017239_dmtec

English

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